

UNISONIC TECHNOLOGIES CO., LTD

6N40-TC

Preliminary

Power MOSFET

6A, 400V N-CHANNEL POWER MOSFET

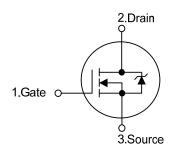
DESCRIPTION

The N-Channel enhancement mode silicon gate power MOSFET is designed for high voltage, high speed power switching applications such as switching regulators, switching converters, solenoid, motor drivers, relay drivers.

FEATURES

- * $R_{DS(ON)}$ < 1.1 Ω @ V_{GS}=10V, I_D=3.0A
- * Avalanche Energy Specified
- * Fast Switching Capability
- * Linear Transfer Characteristics
- * High Input Impedance

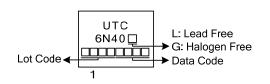
SYMBOL

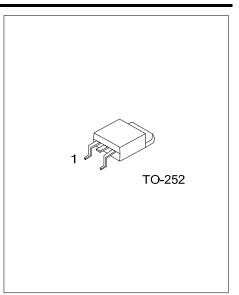


ORDERING INFORMATION

				-				
Ordering Number			Daakaga	Pin Assignment			Deaking	
Lea	d Free	Halogen Free	Package	1	2	3	Packing	
6N40I	-TN3-R	6N40G-TN3-R	TO-252	G	D	S	Tape Reel	
Note: Pin Assignment: G: Gate D: Drain S: Source								
6N40 <u>G</u> - <u>TN3-</u> R								
	(1)Packing Type		(1) R: Tape Reel					
(2)Package Type			(2) TN3: TO-252					
(3)Green Package			(3) G: Halogen Free and Lead Free, L: Lead Free					

MARKING





■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V _{DSS}	400	V	
Gate-Source Voltage		V _{GSS}	±20	V	
Drain Current	Continuous	I _D	6.0	Α	
	Pulsed (Note 2)	I _{DM}	24	А	
Avalanche Current (Note 2)		I _{AR}	4.6	А	
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	106	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.0	V/ns	
Power Dissipation		PD	48	W	
Junction Temperature		TJ	+150	°C	
Storage Temperature		T _{STG}	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L = 10mH, I_{AS} = 4.6A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C

4. $I_{SD} \leq 5.5A$, di/dt $\leq 200A/\mu$ s, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^{\circ}C$

THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT	
Junction to Ambient	θ _{JA}	110	°C/W	
Junction to Case	θις	2.6	°C/W	

ELECTRICAL CHARACTERISTICS (T_J = 25°C, unless otherwise specified)

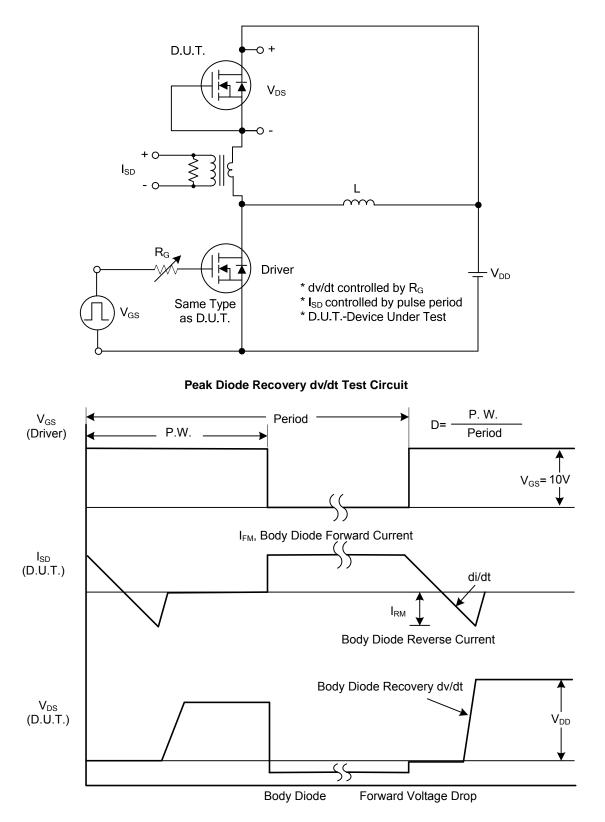
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PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250µA	400			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =Rated BV _{DSS} , V _{GS} =0V			25	μA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V			±100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , Ι _D =250μΑ	2.0		4.0	V
Static Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =3.0A			1.1	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	CISS			485		рF
Output Capacitance	C _{OSS}	V _{GS} =0V,V _{DS} =25V, f=1.0MHz		70		рF
Reverse Transfer Capacitance	C _{RSS}			7		рF
SWITCHING CHARACTERISTICS						
Total Gate Charge (Note 1)	Q_{G}	-V _{DS} =50V, V _{GS} =10V, I _D =1.3A -I _G =100μA (Note1, 2)		35.4		nC
Gate to Source Charge	Q_{GS}			3.6		nC
Gate to Drain Charge	Q_{GD}			5.8		nC
Turn-ON Delay Time (Note 1)	t _{D(ON)}			31		ns
Rise Time	t _R	V _{DS} =30V, V _{GS} =10V, I _D =0.5A,		40		ns
Turn-OFF Delay Time	t _{D(OFF)}	R _G =25Ω (Note1, 2)		117		ns
Fall-Time	t _F	7		38		ns
SOURCE- DRAIN DIODE RATINGS AND CH	ARACTERIS	TICS				
Maximum Body-Diode Continuous Current	ls				6	Α
Maximum Body-Diode Pulsed Current	I _{SM}				24	Α
Drain-Source Diode Forward Voltage (Note 1)	V _{SD}	I _S =6.0A, V _{GS} =0V			1.6	V
Body Diode Reverse Recovery Time (Note 1)	t _{rr}	I _S =6.0A, V _{GS} =0V		220		ns
Body Diode Reverse Recovery Charge	Q _{rr}	dl _F /dt=100A/µs		1.0		μC
Notoo: 1. Bulao Toot: Bulao width < 200up. Dut		<u> </u>				

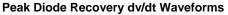
Notes: 1. Pulse Test: Pulse width \leq 300µs, Duty cycle \leq 2%.

2. Essentially independent of operating temperature.



TEST CIRCUITS AND WAVEFORMS







TEST CIRCUITS AND WAVEFORMS

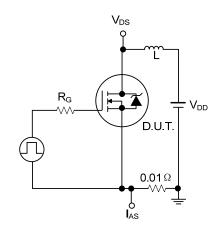


Figure 1A. Unclamped Energy Test Circuit

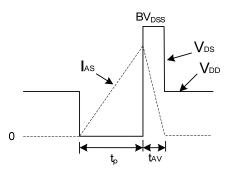


Figure 1B. Unclamped Energy Waveforms

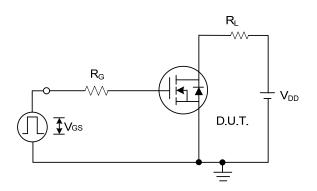


Figure 2A. Switching Time Test Circuit

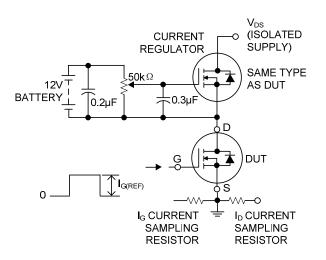


Figure 3A. Gate Charge Test Circuit

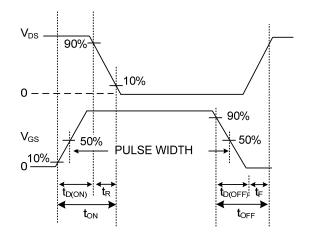
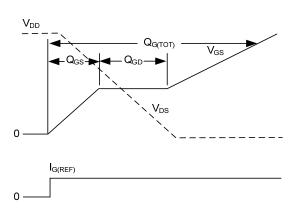


Figure 2B. Resistive Switching Waveforms







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